

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6840530

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HU MIN JUNG	07/28/2021
RECEIVING PARTY DATA	
Name:	DAMOATECH CO., LTD.
Street Address:	#B-604, 723, BUNDANG TECHNOPARK
Internal Address:	PANGYO-RO, BUNDANG-GU
City:	SEONGNAM-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	13511
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17389676
CORRESPONDENCE DATA	
Fax Number:	(617)217-4699
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	617-217-4700
Email:	ipboston.docketing@nelsonmullins.com, david.narkunas@nelsonmullins.com
Correspondent Name:	NELSON MULLINS RILEY & SCARBOROUGH LLP
Address Line 1:	ONE FINANCIAL CENTER, SUITE 3500
Address Line 4:	BOSTON, MASSACHUSETTS 02111
ATTORNEY DOCKET NUMBER:	IN3-017
NAME OF SUBMITTER:	KONGSIK KIM
SIGNATURE:	/Kongsik Kim/
DATE SIGNED:	07/30/2021
Total Attachments: 2	
source=Signed Assignment IN3-017#page1.tif	
source=Signed Assignment IN3-017#page2.tif	

ASSIGNMENT BY INVENTOR

I, JUNG, Hu Min of Seoul, Republic of Korea, for good and valuable consideration paid to me by

DAMOATECH CO., LTD.

a corporation of Republic of Korea, having its principal place of business at, #B-604, 723, Bundang technopark, Pangyo-ro, Bundang-gu, Seongnam-si, Gyeonggi-do, 13511, Republic of Korea the receipt of which is hereby acknowledged, do hereby sell, assign and transfer unto said

DAMOATECH CO., LTD.

its successors and assigns, the entire interest for the United States of America and all foreign countries including all rights of priority under the International Convention for the Protection of Industrial Property in a certain invention or improvement in

MULTI-REGION MOTION SENSOR FOR MOTION FEEDBACK INTERFACE AND METHOD OF OPERATING THE SAME

described in an application

☒ Executed by me of even date herewith and about to be filed

or

☐ Application No. _____, filed on _____

in the United States Patent and Trademark Office, and in all Letters Patent of the United States and all foreign countries which may or shall be granted on said invention, or any parts thereof, or on said application, or any divisional, continuing, reissue or other applications based in whole or in part thereon. And I agree, for myself and my executors and administrators, with said corporation and its successors and assigns but at its or their expense and charges, hereafter to execute all applications, amended specifications, deed or other instrument, and to do all acts necessary or proper to secure the grant of Letters Patent in the United States and in all other countries to said corporation, with specifications and claims in such form as shall be approved by the counsel of said corporation and to vest and confirm in said corporation, its successors and assigns, the legal title to all such patents.

And I do hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said corporation, its successors and assigns.

And I do further hereby grant the attorneys/agents of Nelson Mullins Riley & Scarborough LLP, the power to insert on this Assignment the filing date and/or application number of said application.

Date: July 28, 2021

Signature: 
JUNG, Hu Min